



Label Table	
Variant	Label Text
001	No JTAG header

ZZ1
Label Assembly Note
 This Assembly Note is for PCB labels only

ZZ2
Assembly Note
 These assemblies are ESD sensitive, ESD precautions shall be observed.

ZZ3
Assembly Note
 These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

PCB Number: TIDA-00828
 PCB Rev. E1

PCB LOGO
 Texas Instruments

PCB LOGO
 Pb-Free Symbol

FID1 FID2 FID3

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Orderable: EVM, orderable	Designed for: Public Release	Mod. Date: 12/9/2015
TID #: TID	Project Title: Incremental rotary encoder	
Number: TIDA-00828 Rev. E1	Sheet Title:	
SVN Rev. Version control disabled	Assembly Variant: [No Variations]	Sheet: 1 of 1
Drawn By:	File: TIDA-00828_E1_SCH_SchDoc	Size: B
Engineer: W. Haque	Contact: http://www.ti.com/support	

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